

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM720941

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	Assignment of Intellectual Property Security Agreement		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
Madison Capital Funding LLC		04/01/2022	Limited Liability Company: DELAWARE
RECEIVING PARTY DATA			
Name:	Apogem Capital LLC, as Successor Agent		
Street Address:	227 West Monroe Street, Suite 5400		
City:	Chicago		
State/Country:	ILLINOIS		
Postal Code:	60606		
Entity Type:	Limited Liability Company: DELAWARE		
PROPERTY NUMBERS Total: 10			
Property Type	Number	Word Mark	
Serial Number:	75476114	GEL-PAK	
Serial Number:	76065489	GEL-TRAY	
Serial Number:	76066254	GEL-FILM	
Serial Number:	85513471	KWIKRIP	
Serial Number:	85521904	ULTRALABEL	
Serial Number:	85693159		
Serial Number:	86150253	ULTRATAPE CLEANROOM CERTIFIED PRODUCTS	
Serial Number:	86145559	ULTRATAPE	
Serial Number:	86063460	VERTEC	
Serial Number:	87433928	E-FILM	
CORRESPONDENCE DATA			
Fax Number:	3129021061		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
Phone:	312-577-8438		
Email:	raquel.haleem@katten.com		
Correspondent Name:	Raquel Haleem c/o Katten Muchin Rosenman		
Address Line 1:	525 West Monroe Street		
Address Line 4:	Chicago, ILLINOIS 60661		

CH \$265.00 75476114

NAME OF SUBMITTER:	Raquel Haleem
SIGNATURE:	/Raquel Haleem/
DATE SIGNED:	04/13/2022
Total Attachments: 6 source=Delphon IP Assignment#page1.tif source=Delphon IP Assignment#page2.tif source=Delphon IP Assignment#page3.tif source=Delphon IP Assignment#page4.tif source=Delphon IP Assignment#page5.tif source=Delphon IP Assignment#page6.tif	

**ASSIGNMENT OF INTELLECTUAL PROPERTY
SECURITY AGREEMENTS**

This **ASSIGNMENT OF INTELLECTUAL PROPERTY SECURITY AGREEMENTS** (this “**Assignment**”), dated as of April 1, 2022, is by Madison Capital Funding LLC (individually, “**MCF**”), acting in its capacity as the current and resigning administrative agent (in such capacity, the “**Retiring Agent**”) and Apogem Capital LLC (individually, “**Apogem**”), acting in its capacity as the successor administrative agent (in such capacity, the “**Successor Agent**”). Capitalized terms used but not defined herein shall have the meaning set forth in the applicable IP Security Agreement (as defined below).

RECITALS:

WHEREAS, Delphon Industries, LLC, as “Grantor”, and Retiring Agent are parties to those certain intellectual property security agreements identified in Exhibit A attached hereto (each, an “**IP Security Agreement**,” and collectively, the “**IP Security Agreements**”) pursuant to which Grantor mortgaged, pledged, hypothecated and granted to the Retiring Agent a Lien on and security interest in the Patent Collateral and the Trademark Collateral, including the Patents and Trademarks identified on Exhibit B attached hereto (collectively, the “**IP Collateral**”); and

WHEREAS, pursuant to that certain Omnibus Agency Transfer and Sub-Agent Appointment Agreement by and between MCF, as the Retiring Agent, and Apogem, as the Successor Agent, Retiring Agent has assigned to Successor Agent all of its rights, remedies, duties and other obligations under, among other documents, the Agreements, in each instance, in its capacity as administrative agent and, if applicable, collateral agent.

NOW, THEREFORE, in consideration of the foregoing, and for other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Retiring Agent hereby assigns and transfers to Successor Agent and its successors and assigns, all of its rights, title and interest in and to the IP Security Agreements, including, for the avoidance of doubt, its Lien on and security interest in the IP Collateral and all such rights, powers, privileges and duties of the Retiring Agent under each IP Security Agreement.

This Assignment may be executed in any number of counterparts, each of which when so executed shall be deemed an original and all of which taken together shall constitute one and the same instrument.

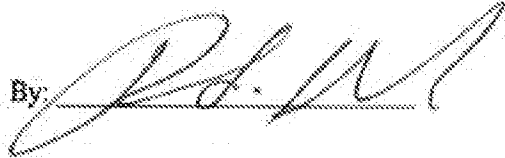
(Remainder of page left intentionally blank; signatures follow.)

IN WITNESS WHEREOF, Retiring Agent and Successor Agent have caused this Assignment to be duly executed as of the date first above written.

RETIRING AGENT:

MADISON CAPITAL FUNDING LLC

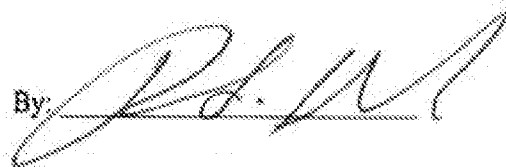
By: Apogem Capital LLC, its manager

By: 

Name: Patrick D. Koehl
Title: Director

SUCCESSOR AGENT:

APOGEM CAPITAL LLC

By: 

Name: Patrick D. Koehl
Title: Director

EXHIBIT A

Patent Security Agreement dated as of January 5, 2018 and filed with the United States Patent and Trademark Office on January 5, 2018 at Reel 044544, Frame 0184.

Trademark Security Agreement dated as of January 5, 2018 and filed with the United States Patent and Trademark Office on January 5, 2018 at Reel 6422, Frame 0027.

EXHIBIT B

Patent Registrations

Patent	Patent Number	Registration Date
Multiple segment vacuum release handling device	7780005	8/24/10

Patent Applications

Location	Patent No. & Issue Date	Expiration Date	Application No. & Filing Date	Earliest Priority Date	Title
US	Pending	Pending	14/216,580	3/17/2014	Silicone-Free Thermoplastic Elastomer (TPE) Materials for Use in Carrier Devices
US	Pending	Pending	15/203,520	07-06-2016	Carrier Devices Having Silicone-Free Thermoplastic Elastomer (TPE) Materials
US	Pending	12-11-2018	62/597,350	12-11-2017	Universal Tape and Reel Carrier Device and Method of Making

Trademark Registrations

Location	Trademark	TM Serial No. & Filing Date	TM Reg & Reg Date	International Class & Description of Goods
US	Gel-Pak	75/476,114 04-28-1998	2,303,631 12-28-1999	IC 9: Carriers, namely, trays and containers for semi-conductor wafers, die, substrates and chips; and mechanical devices comprised of vacuum release trays and pumps for releasing semiconductor wafers, die, substrates and chips from carriers, trays and containers.
US	Gel-Tray	76/065,489 06-06-2000	2,632,660 10-08-2002	IC 9: Carriers, namely, support structures for handling or shipping semi-conductor wafers, die, substrates and chips; mechanical apparatus comprised of vacuum release receptacles and pumps for releasing semiconductor wafers, die, substrates and chips from carriers or support structures.
US	Gel-Film	76/066,254	2,632,661	IC 9: Carriers, namely, support structures for

		06-07-2000	10-08- 2002	handling or shipping semi-conductor wafers, die, substrates and chips.
US	KwikRip	85/513,471 01-10-2012	4278398 01-22-2013	IC 017. Adhesive tape for use in clean room environments; residue-free adhesive tape with serrated edges.
US	UltraLabel	85/521,904 01-20-2012	4274442 01-15-2013	IC 02. Labels and ribbons for use with clean room and thermal label printers; direct thermal labels; thermal transfer labels.
US	Bar Code Design	85/693,159 08-01-2012	4643231 11-25-2014	IC 17: Adhesive tape namely particle free tape for use in clean room environments.
US	UltraTape Cleanroom Certified Products ISO 9001 & Design	86/150,253 12-20-2013	4575447 07-29-2014	IC 17: Adhesive tape for industrial and commercial use.
US	ULTRATAPE	86/145,559 12-17-2013	4571855 07-22-2014	IC 17: Adhesive tape for industrial and commercial use.
US	VERTEC	86/063,460 09-12-2013	4611172 09-23-2014	IC 17: Film used as an industrial or commercial packing; polymer film for commercial and industrial use.
China	GEL PAK	7686630 09-10-2009	7686630 10-07-2012	Cosmetics for animals; soap; mouth-rinsing liquid, polishing preparations; stain removers; incense; essential oil; abrasives
European Community	GEL PAK	8743841 12-09-2009	8743841 06-02-2010	Bleaching preparations and other substances for laundry use; cleaning, polishing, scouring and abrasive preparations; soaps; perfumery, essential oils, cosmetics, hair lotions; dentifrices; material used to collect and/or remove debris generated during testing of integrated circuits or as carriers for integrated circuits.
Hong Kong	Ultratape		303036834 06-17-2014	
International Registration Designations CN, JP, SG	Ultratape		1211865 06-13-2014	
Japan	GEL PAK	2009-070329 09-14-2009	5441685 09-30-2011	Abrasive and tacky pads for removing debris from probes on probe cards for use with testing of integrated circuits.
Korea	GEL PAK	2009-0048086 09-30-2009	40-0855592 03-04-2011	Carbides of metal (abrasives); cleaning preparations; corundum [abrasive]; diamantine [abrasive]; furbishing preparations (polishing preparations); grinding preparations; polishing creams; silicon carbide [abrasive].
Singapore	ULTRATAPE	1211865 (Int'l Reg.) 06-13-2014	T1412593Z 02-26-2015	Adhesive tape for industrial and commercial use.
Taiwan	GEL PAK	98043247 10-01-2009	01436091 11- 01-2010	Solid cleaning preparation for use in industrial manufacturing processes.
Taiwan	Ultratape		103034107 06/17/2014	

Trademark Applications

Trademark	Application Number	Application Date	Jurisdiction
E-FILM	87433928	5/2/17	US